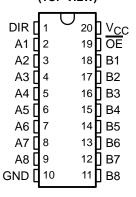
SCLS131C - DECEMBER 1982 - REVISED DECEMBER 2002

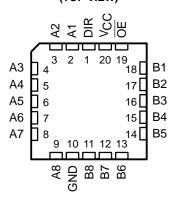
- Wide Operating Voltage Range of 2 V to 6 V
- High-Current 3-State Outputs Drive Bus Lines Directly or Up To 15 LSTTL Loads
- Low Power Consumption, 80-μA Max I<sub>CC</sub>

SN54HC245 . . . J OR W PACKAGE SN74HC245 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)



- Typical t<sub>pd</sub> = 12 ns
- ±6-mA Output Drive at 5 V
- Low Input Current of 1 μA Max

# SN54HC245 . . . FK PACKAGE (TOP VIEW)



## description/ordering information

These octal bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

The devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the device so that the buses are effectively isolated.

#### ORDERING INFORMATION

TA	T <sub>A</sub> PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	SN74HC245N	SN74HC245N
	SOIC - DW	Tube	SN74HC245DW	HC245
	301C - DVV	Tape and reel	SN74HC245DWR	HG245
–40°C to 85°C	SOP - NS	Tape and reel	SN74HC245NSR	HC245
	SSOP – DB	Tape and reel	SN74HC245DBR	HC245
	TSSOP – PW	Tube	SN74HC245PW	HC245
	1330F - FW	Tape and reel	SN74HC245PWR	HG245
	CDIP – J	Tube	SNJ54HC245J	SNJ54HC245J
–55°C to 125°C	CFP – W	Tube	SNJ54HC245W	SNJ54HC245W
	LCCC – FK	Tube	SNJ54HC245FK	SNJ54HC245FK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



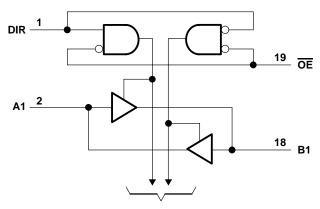
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#### **FUNCTION TABLE**

INP	UTS	OPERATION				
OE	DIR	OPERATION				
L	L	B data to A bus				
L	Н	A data to B bus				
Н	Χ	Isolation				

### logic diagram (positive logic)



To Seven Other Channels

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>		–0.5 V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see	ee Note 1)	±20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CO}$	C) (see Note 1)	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$		±35 mA
Continuous current through V <sub>CC</sub> or GND		±70 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2)	: DB package	70°C/W
	DW package	58°C/W
	N package	69°C/W
	NS package	60°C/W
	PW package	83°C/W
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



## recommended operating conditions (see Note 3)

			AS	SN54HC245		SN	174HC24	15	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vсс	Supply voltage		2	5	6	2	5	6	V
		V <sub>CC</sub> = 2 V	1.5			1.5			
VIН	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15			3.15			V
		VCC = 6 V	4.2			4.2			
		V <sub>CC</sub> = 2 V			0.5			0.5	
VIL	Low-level input voltage	V <sub>CC</sub> = 4.5 V			1.35			1.35	V
		V <sub>CC</sub> = 6 V			1.8			1.8	
٧ <sub>I</sub>	Input voltage		0		VCC	0		VCC	V
٧o	Output voltage		0		VCC	0		VCC	V
		V <sub>CC</sub> = 2 V			1000			1000	
Δt/Δν	Input transition rise/fall time	V <sub>CC</sub> = 4.5 V			500			500	ns
		VCC = 6 V			400			400	
T <sub>A</sub>	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAD	AMETED	TEST CONDITIONS		Vaa	Т	A = 25°C	;	SN54H	IC245	SN74HC245		UNIT
PARAMETER		TEST CONDITIONS		VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
				2 V	1.9	1.998		1.9		1.9		
			$I_{OH} = -20  \mu A$	4.5 V	4.4	4.499		4.4		4.4		
Vон		VI = VIH or VIL		6 V	5.9	5.999		5.9		5.9		V
			$I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		
			$I_{OH} = -7.8 \text{ mA}$	6 V	5.48	5.8		5.2		5.34		
		VI = VIH or VIL	I <sub>OL</sub> = 20 μA	2 V		0.002	0.1		0.1		0.1	
				4.5 V		0.001	0.1		0.1		0.1	
VOL				6 V		0.001	0.1		0.1		0.1	V
			$I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	
			$I_{OL} = 7.8 \text{ mA}$	6 V		0.15	0.26		0.4		0.33	
Ц	DIR or OE	$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA
loz	A or B	$V_O = V_{CC}$ or 0		6 V		±0.01	±0.5		±10		±5	μΑ
ICC		$V_I = V_{CC}$ or 0,	IO = 0	6 V			8		160		80	μΑ
Ci	DIR or OE			2 V to 6 V	·	3	10		10		10	pF

# SN54HC245, SN74HC245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCLS131C - DECEMBER 1982 - REVISED DECEMBER 2002

# switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	Vaa	TA	λ = 25°C	;	SN54H	C245	SN74H	C245	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII	
			2 V		40	105		160		130		
<sup>t</sup> pd	A or B	B or A	4.5 V		15	21		32		26	ns	
			6 V		12	18		27		22		
			2 V		125	230		340		290		
<sup>t</sup> en	ŌĒ	A or B	4.5 V		23	46		68		58	ns	
			6 V		20	39		58		49		
		A or B	2 V		74	200		300		250		
<sup>t</sup> dis	ŌĒ		A or B	4.5 V		25	40		60		50	ns
			6 V		21	34		51		43		
		A or B	2 V		20	60		90		75		
t <sub>t</sub>			4.5 V		8	12		18		15	ns	
				6 V		6	10		15		13	

# switching characteristics over recommended operating free-air temperature range, $C_L$ = 150 pF (unless otherwise noted) (see Figure 1)

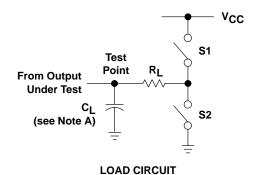
PARAMETER	FROM	то	V	T,	λ = 25°C	;	SN54H	IC245	SN74H	IC245	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII	
			2 V		54	135		200		170		
<sup>t</sup> pd	A or B	B or A	4.5 V		18	27		40		34	ns	
			6 V		15	23		34		29		
		A or B	2 V		150	270		405		335		
t <sub>en</sub>	ŌĒ		A or B	4.5 V		31	54		81		67	ns
			6 V		25	46		69		56		
			2 V		45	210		315		265		
t <sub>t</sub>		A or B	4.5 V		17	42		63		53	ns	
			6 V		13	36		53		45		

# operating characteristics, $T_A = 25^{\circ}C$

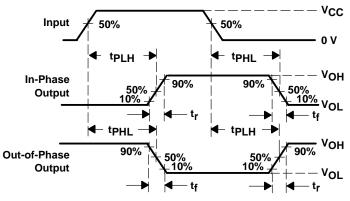
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per transceiver	No load	40	pF



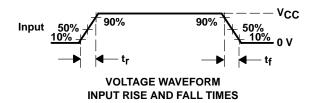
#### PARAMETER MEASUREMENT INFORMATION

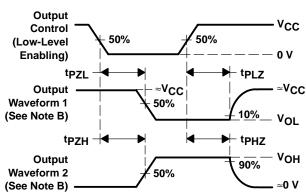


PARAI	METER	RL	CL	S1	S2
	t <sub>PZH</sub> 50 pF		Open	Closed	
ten	tPZL	1 K22	or 150 pF	Closed	Open
4	tdie tPHZ 1 kΩ		50 pF	Open	Closed
<sup>t</sup> dis	tPLZ	1 K22	30 pr	Closed	Open
t <sub>pd</sub> or t <sub>t</sub>		_	50 pF or 150 pF	Open	Open



VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES





VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

- NOTES: A. C<sub>L</sub> includes probe and test-fixture capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_r = 6 \text{ ns}$ .
  - D. The outputs are measured one at a time with one input transition per measurement.
  - E. tpl 7 and tpH7 are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



#### 14 LEADS SHOWN



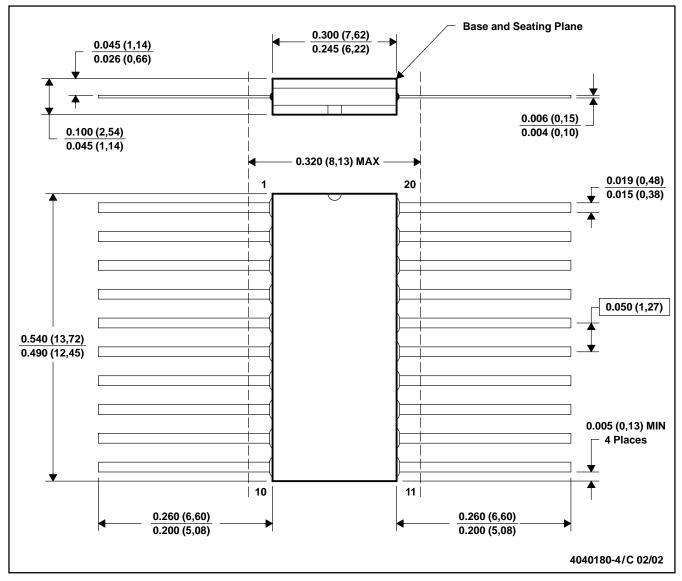
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F20)

#### **CERAMIC DUAL FLATPACK**

1



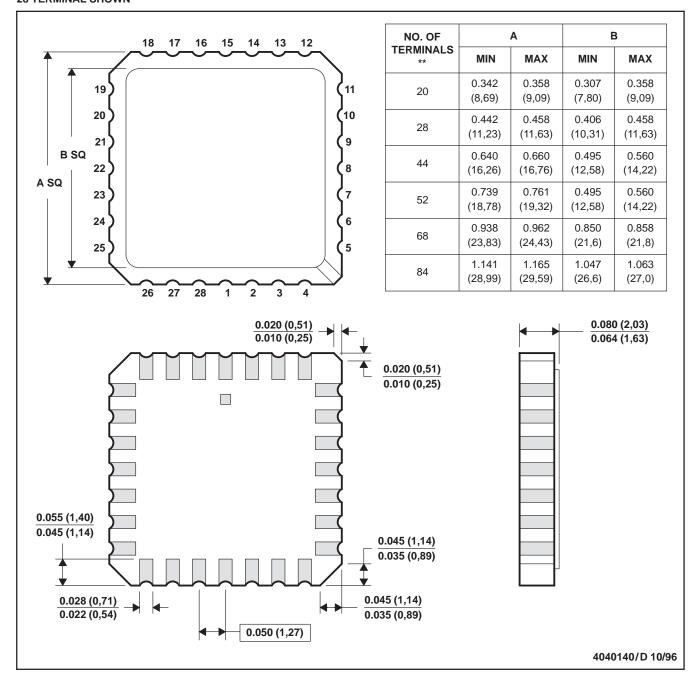
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.

#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### **LEADLESS CERAMIC CHIP CARRIER**



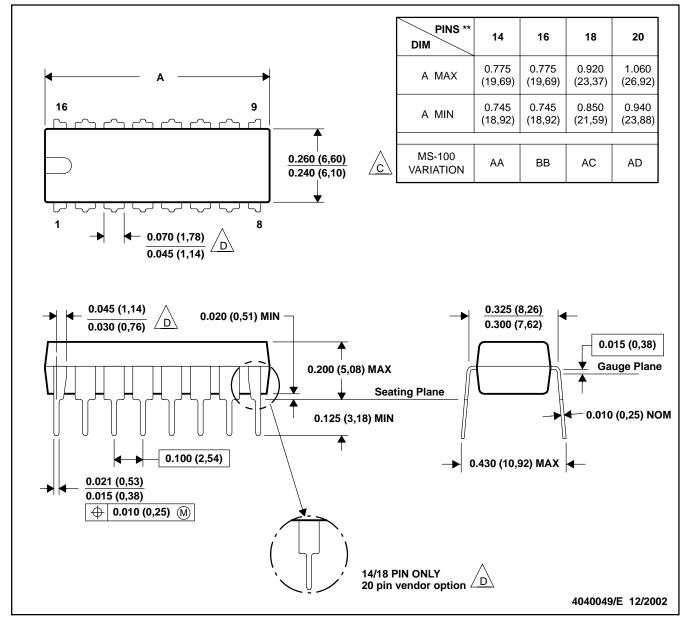
- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004



### N (R-PDIP-T\*\*)

#### **16 PINS SHOWN**

### PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

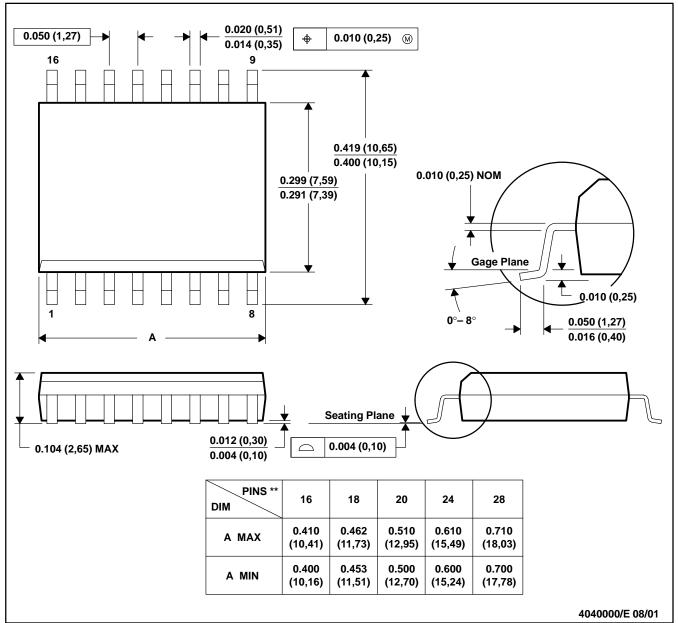
Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

### DW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### **16 PINS SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013

## **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

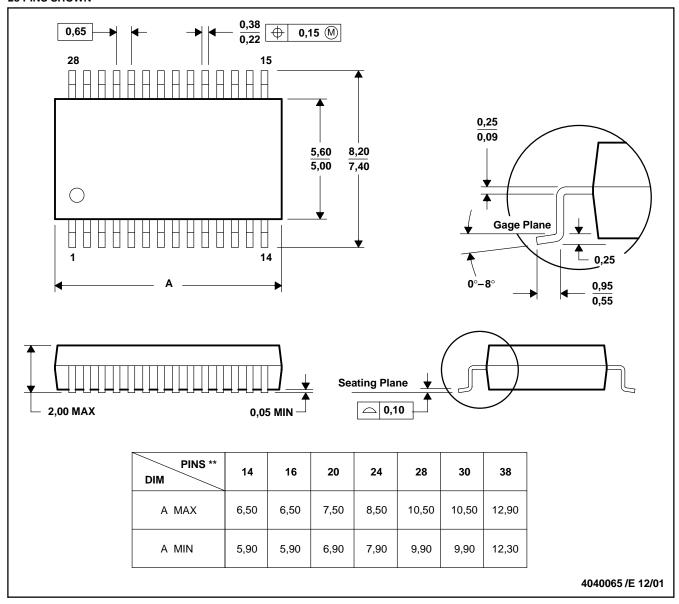
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

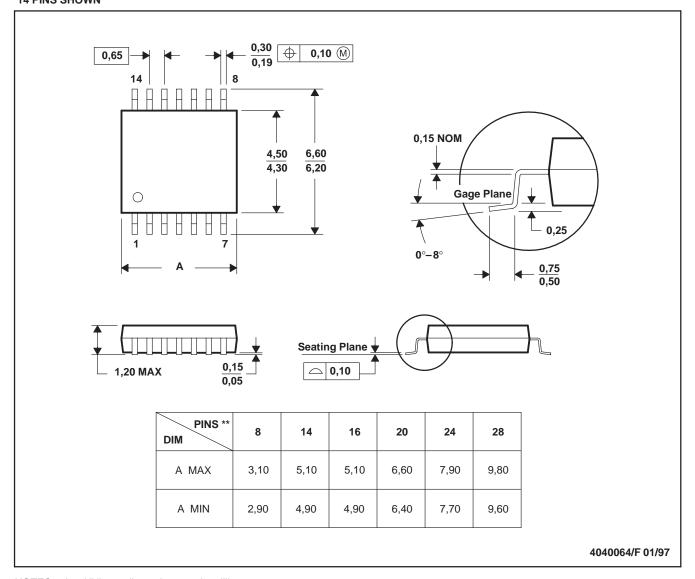
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

## PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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